

# **Silicon on Insulators Market Forecasts to 2032 – Global Analysis By Product (Radio Frequency (RF) Devices, MEMS Devices, Power Semiconductor Devices, Optoelectronics, Memory and Sensors), Wafer Type, Thickness, Wafer Size, Technology, End User and By Geography**

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## **Abstracts**

According to Statistics MRC, the Global Silicon on Insulators Market is accounted for \$1.78 billion in 2025 and is expected to reach \$5.46 billion by 2032 growing at a CAGR of 17.3% during the forecast period. In the silicon on insulator (SOI) fabrication process, a thin layer of silicon is deposited on top of an insulating substrate, usually silicon dioxide. By lowering parasitic device capacitance, this structure outperforms traditional bulk silicon in terms of performance and power efficiency. RF applications, high-speed or low-power integrated circuits, and sophisticated microprocessors all make extensive use of SOI technology. It is perfect for contemporary electronic devices where compactness and energy efficiency are crucial because of its capacity to reduce leakage current and increase switching speed.

According to the Semiconductor Industry Association (SIA), global semiconductor industry sales totaled \$627.6 billion in 2024, reflecting a 19.1% increase compared to the previous year.

Market Dynamics:

Driver:

Growing use of automotive electronics

The emergence of autonomous driving technologies, connected car ecosystems, and electric vehicles (EVs) is transforming the automotive industry. These developments mainly depend on semiconductor devices that are dependable and high-performing even in harsh environments. SOI chips are ideal for safety-critical systems like braking, steering, and navigation because of their exceptional thermal conductivity, resistance to latch-up, and immunity to soft errors. Furthermore, the durability and long-term dependability that SOI devices offer are becoming more and more valued by automotive standards like AEC-Q100.

#### Restraint:

##### Exorbitant production and material expenses

One of the main obstacles preventing SOI technology from being widely used is the comparatively high cost of fabrication. Compared to traditional bulk silicon wafer manufacturing, the production of SOI wafers requires more resource-intensive, complex processes like SIMOX and the Smart Cut™ method. Furthermore, because SOI substrates require precise control over layer thickness and have an extra insulating oxide layer, their cost is much higher. Moreover, the limited R&D budgets of small and medium-sized semiconductor companies are also impacted by cost constraints, which prevent wider industry penetration.

#### Opportunity:

##### Growing use of autonomous and electric vehicles

One of the biggest growth opportunities for SOI devices is the rapidly accelerating shift to electric vehicles (EVs) and autonomous driving technologies. These cars need electronics that are highly reliable and able to function in harsh conditions and a wide range of temperatures. SOI is the perfect choice for advanced driver-assistance systems (ADAS) sensors, power management integrated circuits, and automotive microcontrollers due to its exceptional high-temperature performance and resistance to latch-up and soft errors. Additionally, a strong long-term opportunity for SOI technology will arise as EV adoption increases and the demand for reliable and power-efficient semiconductors rises, particularly as vehicle electronics become more software-driven and networked.

#### Threat:

## Increasing rivalry with other semiconductor technologies

Despite SOI's benefits, other semiconductor technologies—most notably FinFET and advanced bulk CMOS—are a serious threat. At advanced process nodes, FinFET in particular is widely used due to its exceptional power efficiency and scalability. Large foundries like TSMC and Intel have a competitive edge in terms of maturity, cost-effectiveness at scale, and ecosystem support because they have optimized their FinFET processes for mass production. Furthermore, bulk silicon technologies keep getting better at controlling leaks and performing better, which puts SOI's distinctive value proposition in jeopardy, particularly in high-volume manufacturing and consumer electronics that are cost-sensitive.

### Covid-19 Impact:

The COVID-19 pandemic affected the silicon on insulators (SOI) market in a variety of ways. Delays in semiconductor production and SOI wafer deliveries were initially caused by workforce shortages, factory closures, and global supply chain disruptions, which had an impact on end-use industries like consumer electronics and the automotive sector. The pandemic did, however, also hasten digital transformation by raising demand for data centers, 5G infrastructure, and connected devices—all of which depend on high-performance, energy-efficient semiconductors, of which SOI technology is essential. Moreover, the long-term outlook for the SOI market improved as remote work, online services, and edge computing gained popularity.

The radio frequency (RF) devices segment is expected to be the largest during the forecast period

The radio frequency (RF) devices segment is expected to account for the largest market share during the forecast period. The growing use of SOI-based RF chips in smart phones, tablets, and 5G communication systems is primarily responsible for this dominance. RF-SOI technology is perfect for front-end modules used in wireless communication because it provides high performance at high frequencies, low power consumption, and excellent isolation. Demand for RF-SOI devices is still being driven by the increase in global mobile data traffic, as well as the development of 5G infrastructure and IoT connectivity. Furthermore, RF applications play a significant role in the expansion of the SOI market as a whole.

The smart cut segment is expected to have the highest CAGR during the forecast

period

Over the forecast period, the smart cut segment is predicted to witness the highest growth rate. The precise layer transfer made possible by Smart Cut technology makes it possible to fabricate thin, homogeneous silicon layers on insulating substrates with great accuracy and few flaws. This technique is frequently used to create sophisticated SOI wafers with improved scalability, lower power consumption, and superior electrical performance—all of which are critical for next-generation semiconductor applications like 5G, artificial intelligence, and high-speed computing. Moreover, its quick rise in the global SOI market is being fueled by its expanding use in RF devices, power electronics, and high-performance logic circuits.

Region with largest share:

During the forecast period, the North America region is expected to hold the largest market share, driven by the widespread adoption of cutting-edge technologies across industries, the presence of prominent semiconductor companies, and sophisticated research facilities. Strong demand for SOI-based products in industries like consumer electronics, autonomous vehicles, defense systems, and 5G infrastructure benefits the region. With large investments in semiconductor fabrication and design, the U.S. in particular is a major center for innovation in RF devices, MEMS, and power semiconductors. Additionally, North America's dominance in the SOI market is being further cemented by government initiatives that support domestic chip manufacturing and the growth of 5G networks.

Region with highest CAGR:

Over the forecast period, the Asia Pacific region is anticipated to exhibit the highest CAGR. The region's growing electronics manufacturing base, increased investments in semiconductor fabrication and growing use of SOI technology in cutting-edge applications like 5G, IoT, and electric vehicles are all contributing factors to this quick growth. Leading the way are nations like China, South Korea, Taiwan, and Japan, who have substantial R&D expenditures, supportive governments, and advantageous policies. Furthermore, Asia-Pacific's adoption of SOI is further accelerated by the rise in demand for high-performance, energy-efficient chips in consumer electronics and industrial automation.

Key players in the market

Some of the key players in Silicon on Insulators Market include Murata Manufacturing Co., Ltd., IBM, Sumco Corporation, Qorvo, Inc., Shin-Etsu Chemical Co., Ltd., NXP Semiconductors N.V., Magnachip Semiconductor Inc, Qualcomm Inc., Wafer World Inc., Silicon Valley Microelectronics, Inc., United Microelectronics Corporation, STMicroelectronics N.V., Intel Corporation, Skyworks Solutions, Inc. and Ultrasil Corporation.

#### Key Developments:

In February 2025, Murata Electronics (India) Private Limited, a subsidiary of Murata Manufacturing Co. Ltd., has signed an agreement to lease a factory at the OneHub Chennai Industrial Park, Tamil Nadu. The Japanese firm will commence full-scale operation in financial year 2026.

In February 2025, NXP Semiconductors N.V. announced it has entered into a definitive agreement to acquire Kinara, Inc., an industry leader in high performance, energy-efficient and programmable discrete neural processing units (NPUs). These devices enable a wide range of edge AI applications, including multi-modal generative AI models.

In September 2024, IBM and L&T Semiconductor Technologies (SiLT) have signed an agreement to co-develop advanced processors for edge devices, hybrid cloud systems and areas like mobility, industrial, energy, and servers. In a social media post, Union Minister for Information and Broadcasting and Electronics and IT Ashwini Vaishnaw said that this partnership will boost India's semiconductor capabilities by creating competitive products for global markets.

#### Products Covered:

Radio Frequency (RF) Devices

MEMS Devices

Power Semiconductor Devices

Optoelectronics

Memory

## Sensors

### Wafer Types Covered:

Radio Frequency Silicon on Insulator (RF-SOI)

Fully Depleted Silicon on Insulator (FD-SOI)

Partially Depleted Silicon on Insulator (PD-SOI)

Power SOI

Other Wafer Types

### Thicknesses Covered:

Thin-film SOI Wafers

Thick-film SOI Wafers

### Wafer Sizes Covered:

200mm

300mm

### Technologies Covered:

Bonding Technology

Epitaxial Layer Transfer (ELTRAN)

Silicon On Sapphire (SOS)

Separation By Implantation of Oxygen (SIMOX)

Smart Cut

End Users Covered:

Automotive

Aerospace and Defense

Consumer Electronics

Entertainment and Gaming

Datacom and Telecom

Industrial Applications

Photonics

Regions Covered:

North America

US

Canada

Mexico

Europe

Germany

UK

Italy

France

Spain

Rest of Europe

#### Asia Pacific

Japan

China

India

Australia

New Zealand

South Korea

Rest of Asia Pacific

#### South America

Argentina

Brazil

Chile

Rest of South America

#### Middle East & Africa

Saudi Arabia

UAE

Qatar

South Africa

Rest of Middle East & Africa

What our report offers:

- Market share assessments for the regional and country-level segments
- Strategic recommendations for the new entrants
- Covers Market data for the years 2024, 2025, 2026, 2028, and 2032
- Market Trends (Drivers, Constraints, Opportunities, Threats, Challenges, Investment Opportunities, and recommendations)
- Strategic recommendations in key business segments based on the market estimations
- Competitive landscaping mapping the key common trends
- Company profiling with detailed strategies, financials, and recent developments
- Supply chain trends mapping the latest technological advancements

Free Customization Offerings:

All the customers of this report will be entitled to receive one of the following free customization options:

#### Company Profiling

Comprehensive profiling of additional market players (up to 3)

SWOT Analysis of key players (up to 3)

#### Regional Segmentation

Market estimations, Forecasts and CAGR of any prominent country as per the client's interest (Note: Depends on feasibility check)

#### Competitive Benchmarking

Benchmarking of key players based on product portfolio, geographical presence, and strategic alliances

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